

Product Change Notification / RMES-24PXYB706

D.	a t	^	
v	3 L	C	

26-Aug-2021

Product Category:

Linear Op Amps

PCN Type:

Manufacturing Change

Notification Subject:

CCB 3269.001 Final Notice: Qualification of UTL3 as an additional assembly site for selected MCP60x1, MCP60x2, MCP6232 and MCP64x2 device families available in 8L TDFN (2x3x0.8mm) package.

Affected CPNs:

RMES-24PXYB706_Affected_CPN_08262021.pdf RMES-24PXYB706_Affected_CPN_08262021.csv

Notification Text:

PCN Status:

Final notification

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the files found in the Affected CPNs section.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of UTL3 as an additional assembly site for selected MCP60x1, MCP60x2, MCP6232 and MCP64x2 device families available in 8L TDFN (2x3x0.8mm) package.

Pre and Post Change Summary:

	Pre Change	Post Change		
Assembly Site	UTAC Thai Limited (UTL-1) LTD.	UTAC Thai Limited (UTL-1) LTD.	UTAC Thai Limited (UTL-3)	
	(NSEB)	(NSEB)	(UTL3)	
Wire material	Au	Au	Au	
Die attach material	8600	8600	8600	
Molding compound material	G700LTD	G700LTD	G700LTD	
Lead frame material	C194	C194	C194	

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:

To improve manufacturability and productivity by qualifying UTL3 as an additional assembly site

Change Implementation Status:

In Progress

Estimated First Ship Date:

September 05, 2021 (date code: 2137)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	August 2021			September 2021					
Workweek	3 2	3	3 4	3 5	36	37	38	39	40
Qual Report Availability				Χ					
Final PCN Issue Date				Χ					
Estimated Implementation Date						Х			

Method to Identify Change:

Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual_Report

Revision History: August 26, 2021: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.
Attachments:
PCN_RMES-24PXYB706_Qual_Report.pdf
Please contact your local Microchip sales office with questions or concerns regarding this notification.
Terms and Conditions:
If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.
If you wish to <u>change your PCN profile, including opt out,</u> please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

RMES-24PXYB706 - CCB 3269.001 Final Notice: Qualification of UTL3 as an additional assembly site for selected MCP60x1, MCP60x2, MCP6232 and MCP64x2 device families available in 8L TDFN (2x3x0.8mm) package.

Affected Catalog Part Numbers (CPN)

MCP6051T-E/MNY

MCP6061T-E/MNY

MCP6071T-E/MNY

MCP6052T-E/MNY

MCP6062T-E/MNY

MCP6072T-E/MNY

MCP6232T-E/MNY

MCP6402T-E/MNY

MCP6442T-E/MNY

Date: Thursday, August 26, 2021